TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS IV)

# **TPC8042**

Lithium-Ion Battery Applications
Portable Equipment Applications
Notebook PC Applications

- Small footprint due to a small and thin package
- Low drain-source ON-resistance:  $R_{DS}$  (ON) = 2.7 m $\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 42 \text{ S (typ.)}$
- Low leakage current:  $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement mode:  $V_{th} = 1.3 \text{ to } 2.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	30	> v
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	30	V
Gate-source voltage		$V_{GSS}$	±20	V
Drain current	DC (Note 1)	I <sub>D</sub> 〈	18	A
	Pulse (Note 1)	I <sub>DP</sub>	72	
Drain power dissipation (t = 10 s) (Note 2a)		PD	1.9	w
Drain power dissipation $(t = 10 \text{ s})$ (Note 2b)		PD	1.0	M
Single pulse avalanche energy (Note 3)		Eas	84	mJ
Avalanche current		) I <sub>AR</sub>	(18// \$)	Α
Repetitive avalanche energy (Note 2a) (Note 4)		E <sub>AR</sub>	0.044	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C

Note: For Notes 1 to 4, refer to the next page.

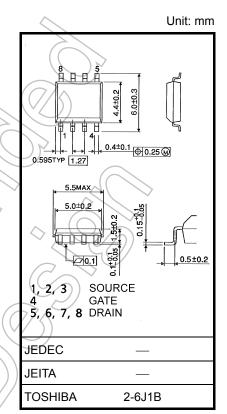
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

temperature, etc.) may cause this product to decrease in the

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

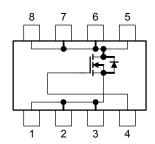
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.



Weight: 0.08 g (typ.)

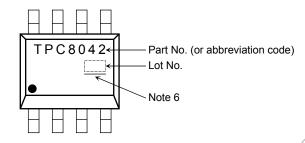
### **Circuit Configuration**



#### **Thermal Characteristics**

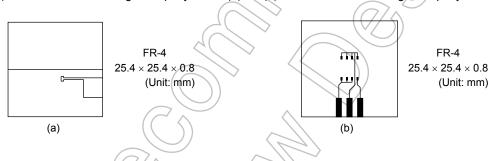
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W

### Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (b) Device mounted on a glass-epoxy board (b)



Note 3:  $V_{DD} = 24 \text{ V}$ ,  $T_{ch} = 25 ^{\circ}\text{C}$  (initial), L = 0.2 mH,  $I_{AR} \neq 18 \text{ A}$ 

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

\* Weekly code: (Three digits)

Week of manufacture
(01 for first week of year, continuing up to 52 or 53)

Year of manufacture
(The last digit of the calendar year)

Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

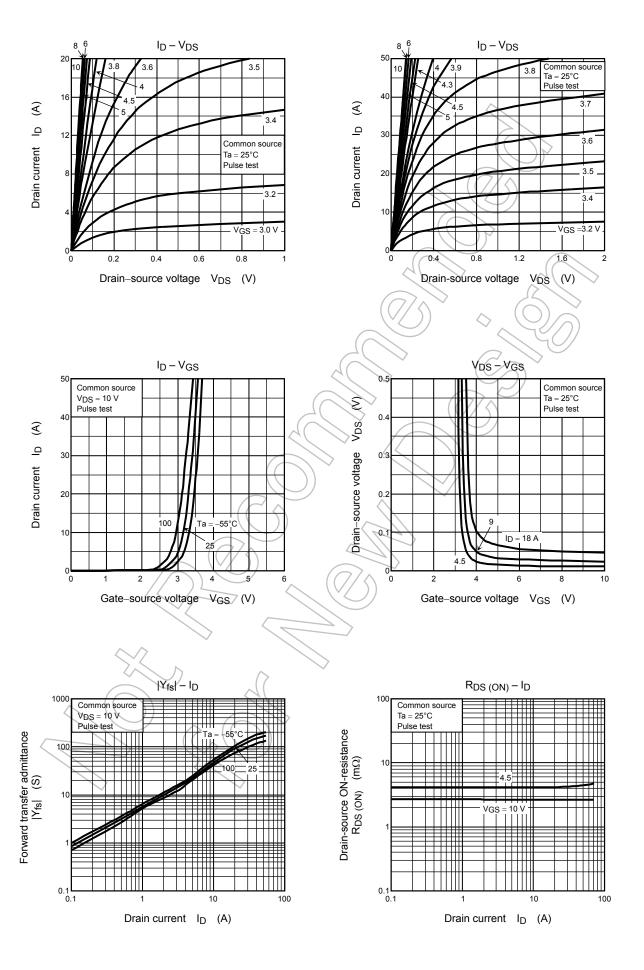
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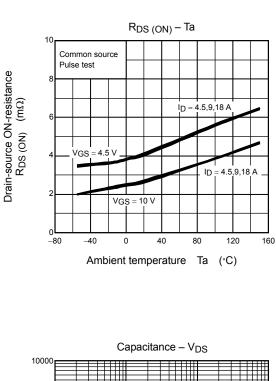
## **Electrical Characteristics (Ta = 25°C)**

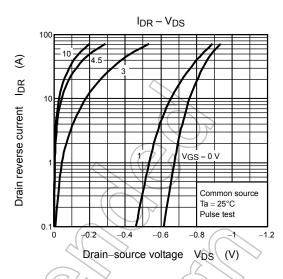
Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA	
Drain cut-OFF cu	ırrent	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	_	_	10	μА	
Drain-source breakdown voltage		V <sub>(BR)DSS</sub>	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V	
		V <sub>(BR) DSX</sub>	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	10	_	_	V	
Gate threshold vo	oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.3	) /_	2.5	V	
Drain-source ON-resistance		R <sub>DS</sub> (ON)	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 9 A	) <u> </u>	4.2	6.5	- mΩ	
			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A	$\mathcal{P}$	2.7	3.4		
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 9 A	21	42	_	S	
Input capacitance		C <sub>iss</sub>		_	2900	_		
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	460	_	pF	
Output capacitance		Coss			800	$\nearrow$		
Switching time	Rise time	t <sub>r</sub>	V <sub>GS</sub> 10 V D = 9 A	-(	18	> _		
	Turn-on time	t <sub>on</sub>	2.7.7.7.1 = 1.67.0 D		32	_	ns	
	Fall time	t <sub>f</sub>	V <sub>DD</sub> ≈ 15 V		25			
	Turn-off time	t <sub>off</sub>	Duty ≤ 1%, t <sub>w</sub> = 10 μs		81			
Total gate charge (gate-source plus		Qg			56	_		
Gate-source charge 1		Q <sub>gs1</sub>	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 18 \text{ A}$	_	9	_	nC	
Gate-drain ("miller") charge		Qgd		_	17	_		

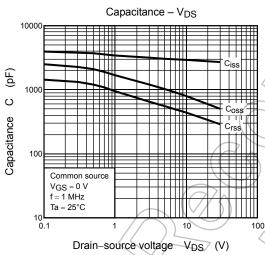
# Source-Drain Ratings and Characteristics (Ta = 25°C)

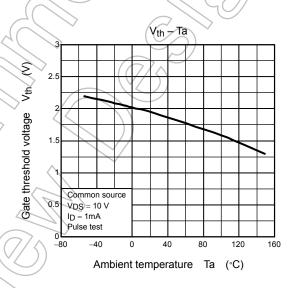
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note 1)	I <sub>DRP</sub>		_	_	72	Α
Forward voltage (diode)	$V_{DSF}$	I <sub>DR</sub> = 18 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V

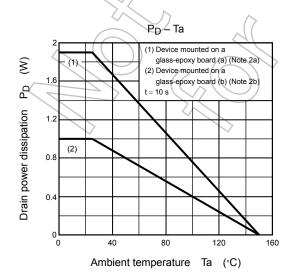


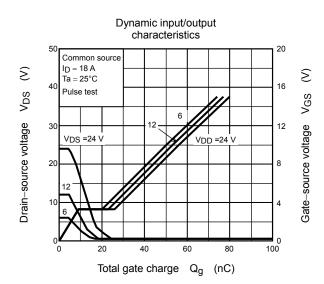




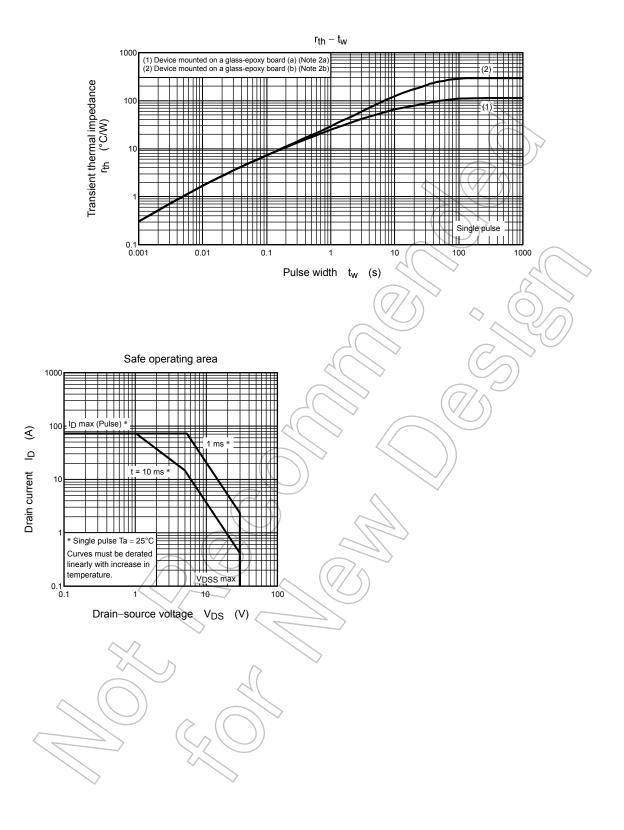








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